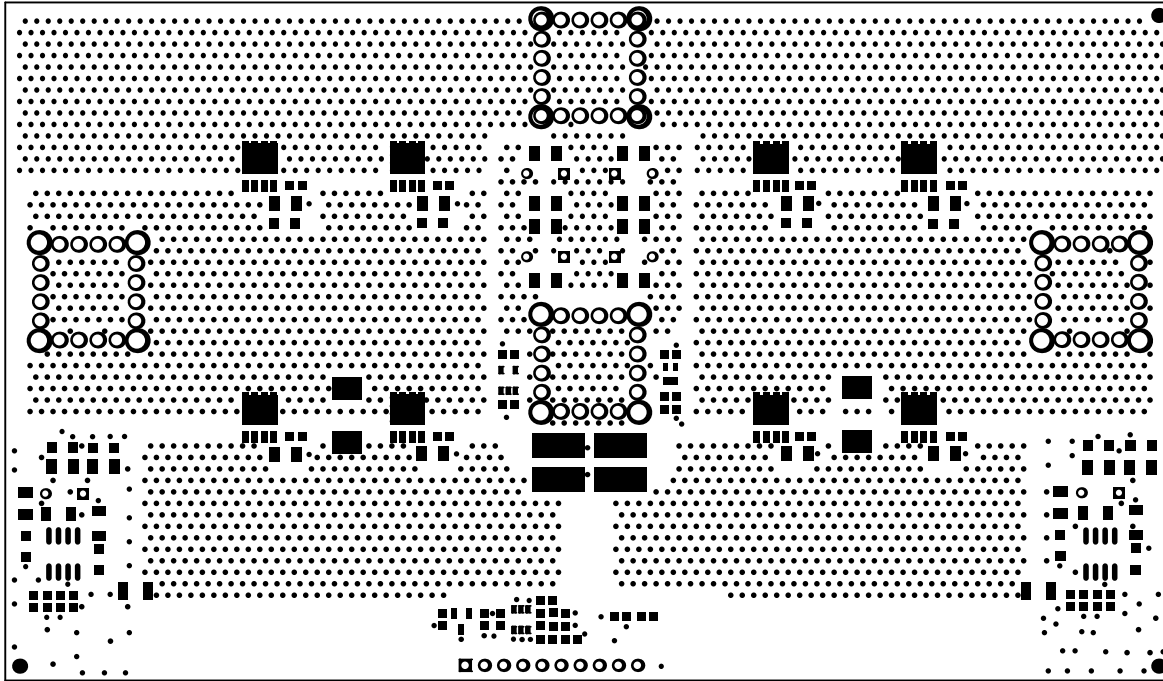
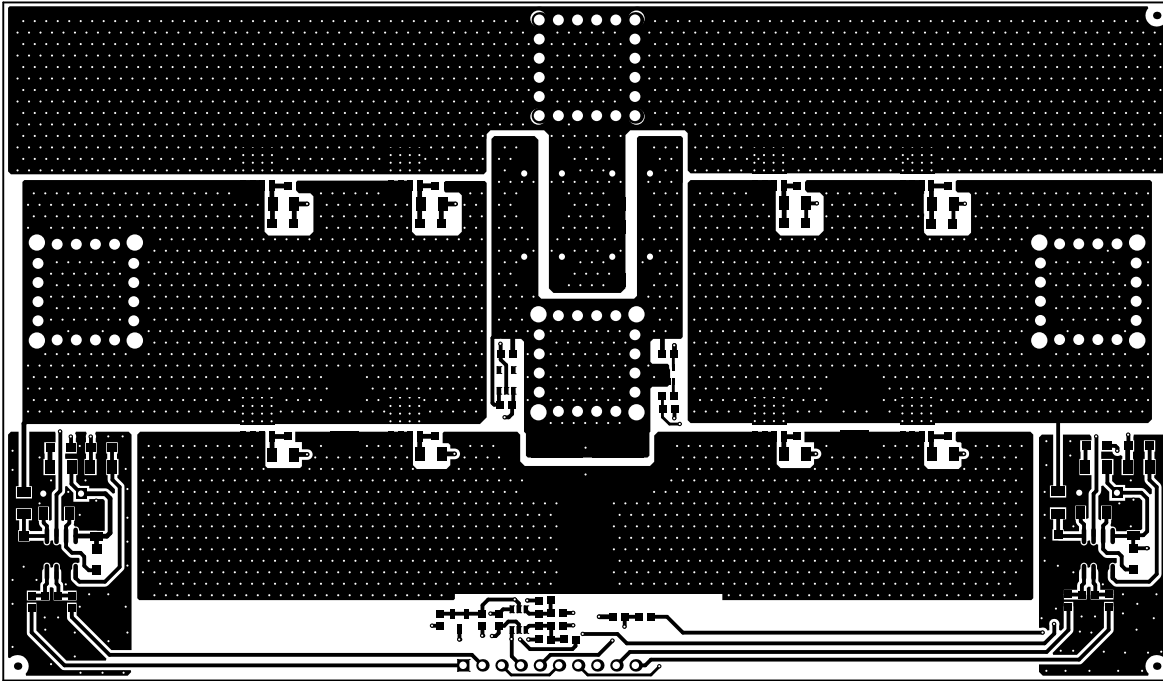


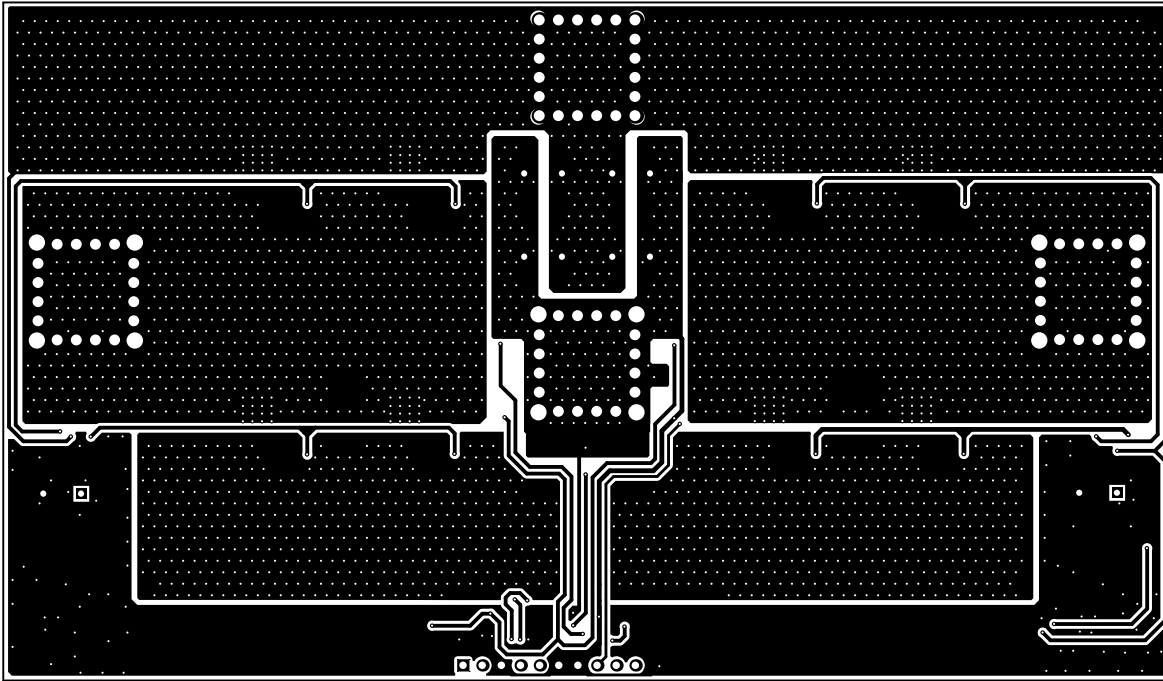
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01292		
PLOT NAME = Top Overlay	GENERATED : 7/31/2017 1:49:57 PM	TEXAS INSTRUMENTS	



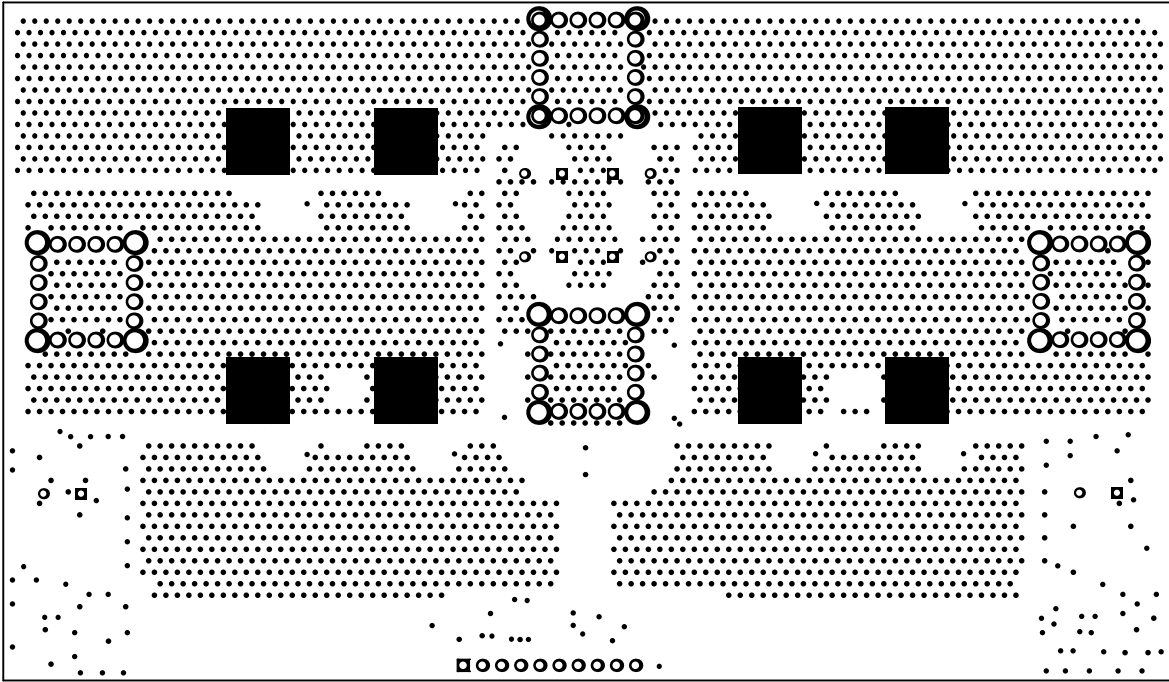
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01292		
PLOT NAME = Top Solder Mask	GENERATED : 7/31/2017 1:49:59 PM	TEXAS INSTRUMENTS	



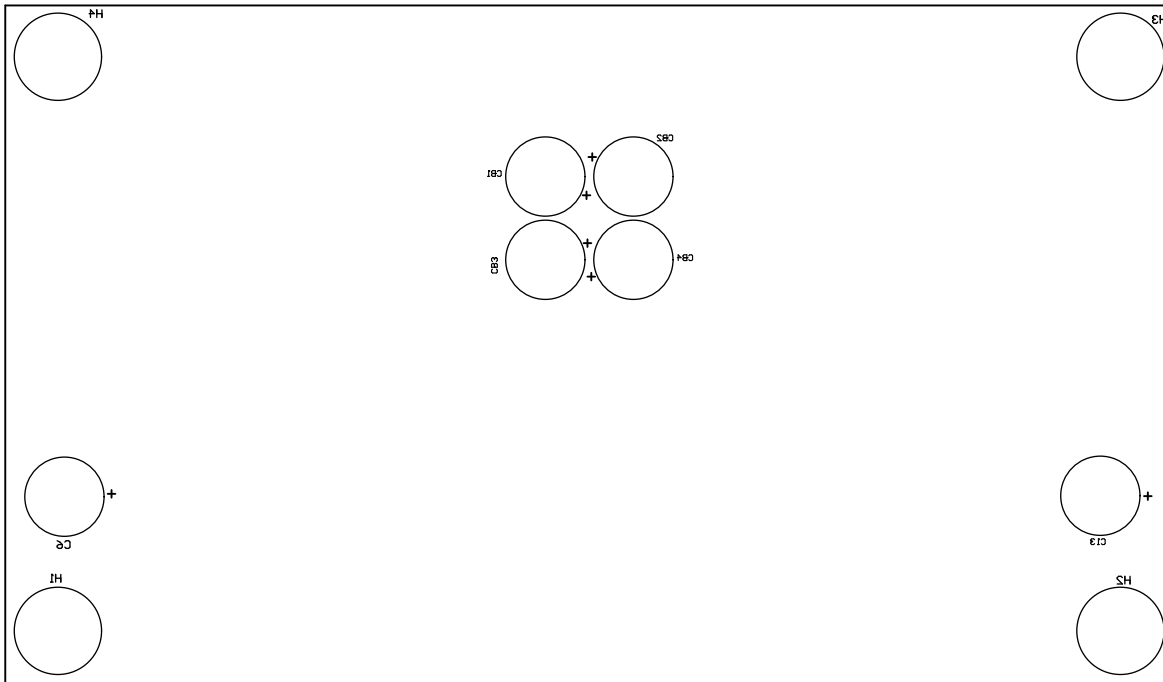
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01292		
PLOT NAME = Top Layer	GENERATED : 7/31/2017 1:50:01 PM	TEXAS INSTRUMENTS	



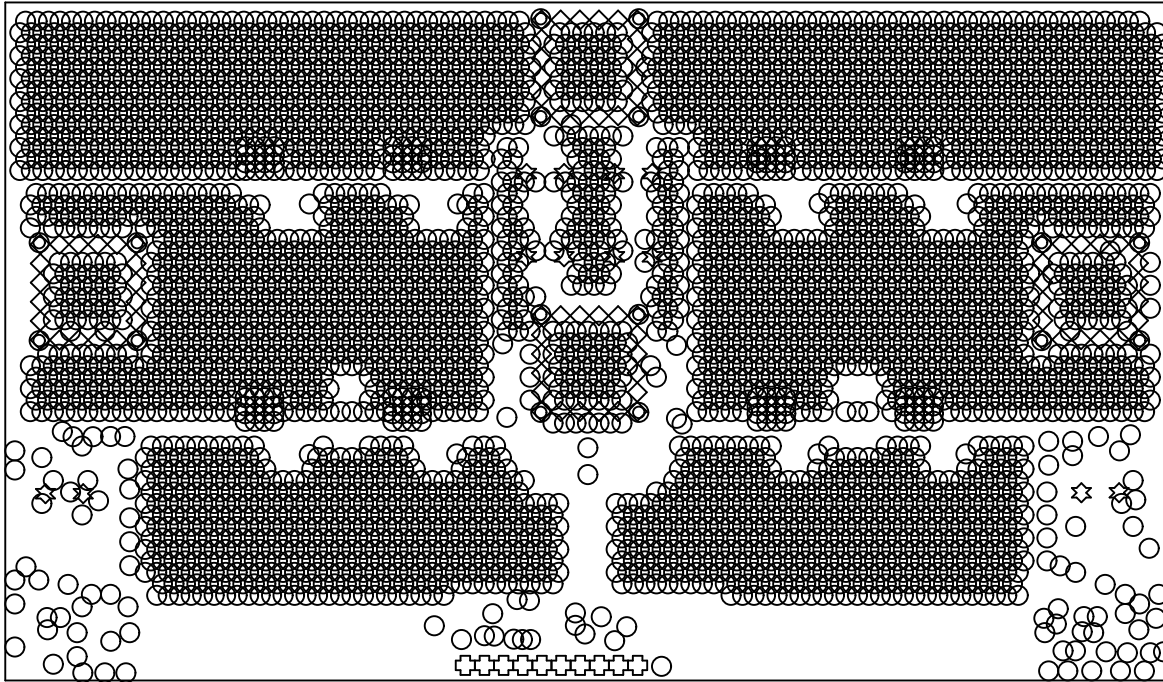
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01292		
PLOT NAME = Bottom Layer	GENERATED : 7/31/2017 1:50:03 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01292		
PLOT NAME = Bottom Solder Mask	GENERATED : 7/31/2017 1:50:04 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01292		
PLOT NAME = Bottom Overlay	GENERATED : 7/31/2017 1:50:06 PM	TEXAS INSTRUMENTS	



DRILL TABLE

Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
○	3910	12.00mil (0.30480mm)	PTH	Round
◇	80	58.07mil (1.47500mm)	PTH	Round
●	16	86.61mil (2.20000mm)	PTH	Round
✱	12	33.46mil (0.85000mm)	PTH	Round
⊕	10	40.00mil (1.01600mm)	PTH	Round
	4028 Total			

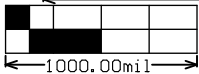
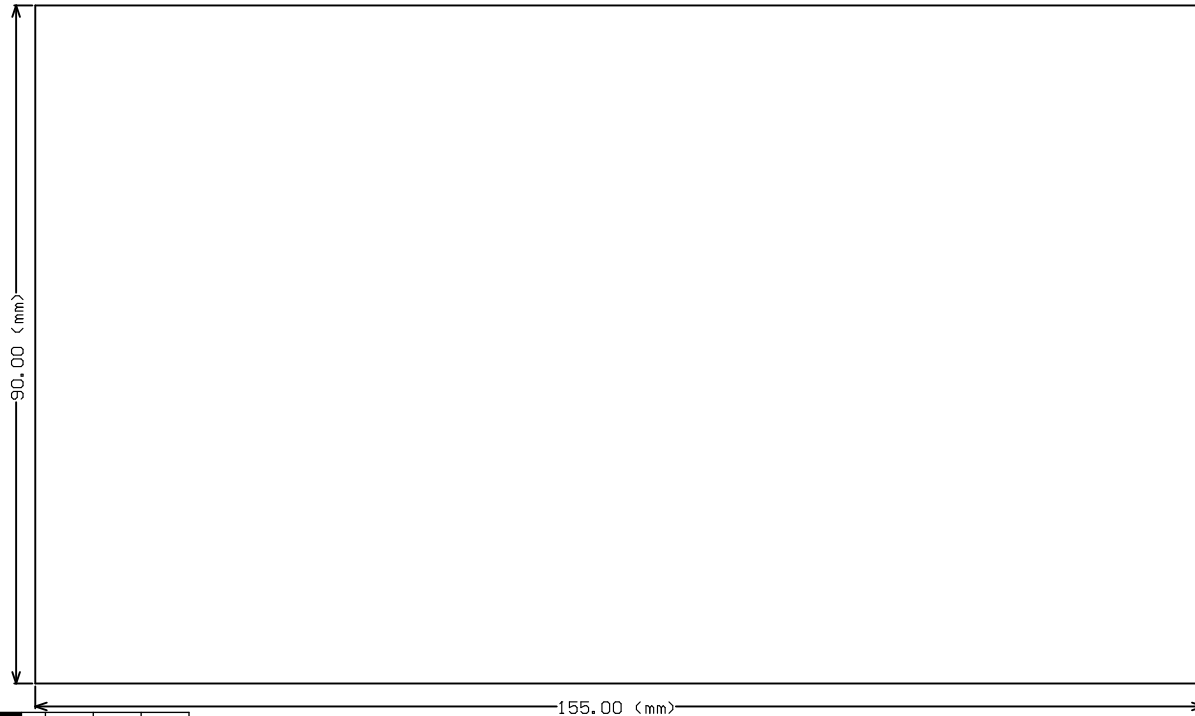
FOR PTH +3/-3MIL

FOR 12MIL DRILL +0/-12MIL

Copper thickness is 2oz.

This is not an Impedance control board.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01292		
PLOT NAME = Drill Drawing	GENERATED : 7/31/2017 1:50:08 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01292	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01292		
PLOT NAME = Board Dimensions	GENERATED : 7/31/2017 1:50:10 PM	TEXAS INSTRUMENTS	

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